



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q62338

Moriyasu SHIMOJO, et al.

Appln. No.: 09/720,343

Group Art Unit: 1714

Confirmation No.: 1114

Examiner: Katarzyna W. Lee

Filed: December 22, 2000

For: THERMOPLASTIC RESIN COMPOSITION AND INJECTION MOLDINGS
THEREOF

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated March 13, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Please enter the following amended claims:

a' 7. (Amended) The thermoplastic resin composition according to claim 5 or 6 wherein the thermoplastic resin composition satisfies the following expressions 1)-3) and the melt flow rate of the composition is not less than 35 g/10 min as determined according to JIS-K-6758 at 230°C:

- 1) $(X_{pp}) + (X_{st}) + (X_{EOR}) + (X_{EBR}) + (X_{EPR}) + (X_{talc}) = 100,$
- 2) $0.20 \leq \{ [(Y_{BC}) \times (Y_{EP}) + (X_{st}) + (X_{EOR}) + (X_{EBR}) + (X_{EPR})] / 100 \} \leq 0.30,$ and
- 3) $0.1 \leq \{ (Y_{BC}) \times (Y_{EP}) / [(Y_{BC}) \times (Y_{EP}) + (X_{st}) + (X_{EOR}) + (X_{EBR}) + (X_{EPR})] \},$

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